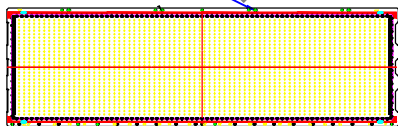


框架传送方向 (装片):  
L/F Direction (D/A): 椭圆孔



注意: 基岛全镀银

实物图:  
Chip photo:

特殊说明 Special Instructions:

DFN10L(3×3×0.75-0.5)(71×76)(32×25)(32×25mil<sup>2</sup>)(1 block)  
(1800×1935)(825×635)(825×635um<sup>2</sup>)